

**RADIATION SENSITIVE RESIN COMPOSITION FOR FORMING INSULATION
FILM OF ORGANIC EL DISPLAY ELEMENT, INSULATION FILM FORMED FROM
THE SAME AND ORGANIC EL DISPLAY ELEMENT**

Patent number: JP2002182380
Publication date: 2002-06-26
Inventor: SUZUKI MASAMUTSU; SASAKI HIROBUMI;
NISHIMURA ISAO; NIWA KAZUAKI
Applicant: JSR CORP
Classification:
- International: G03F7/022; C08K5/28; C08L101/06; G03F7/032;
G03F7/038; H05B33/14; H05B33/22
- european:
Application number: JP20000379680 20001214
Priority number(s):

Abstract of JP2002182380

PROBLEM TO BE SOLVED: To provide a radiation sensitive resin composition for forming an insulation film of an organic EL(electroluminescent) element capable of forming a through hole or a U-shaped recess, excellent in flattening performance and having high transparency and high resistance to a resist removing solution and to provide an insulation film of an organic EL element formed from the composition and an organic EL display element with the insulation film.

SOLUTION: The composition contains (a) an epoxy-containing alkali-soluble resin and (b) a 1,2-quinonediazido compound. The insulation film is formed from the composition. The organic EL display element has the insulation film.

Data supplied from the **esp@cenet** database - Worldwide

BEST AVAILABLE COPY